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Dual N-Channel 60 V (D-S) MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	60				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.058				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.072				
Q _g typ. (nC)	13				
I _D (A) ^a	5.3				
Configuration	Dual				

FEATURES

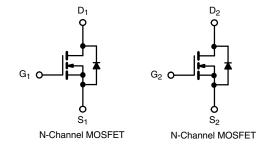
- TrenchFET® power MOSFET
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- LCD TV CCFL inverter
- · Load switch



ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si9945BDY-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	60	V	
Gate-source voltage		V _{GS}	± 20		
	T _C = 25 °C		5.3	A	
Continuous dusin surrent /T 150 °C)	T _C = 70 °C	l , 🗀	4.3		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	4.3 b, c		
	T _A = 70 °C		3.4 b, c		
Pulsed drain current (10 µs width)		I _{DM}	20		
Continuous source during diagle sourcest	T _C = 25 °C		2.6		
Continuous source-drain diode current	T _A = 25 °C	I _S	1.7 ^{b, c}		
Avalanche current	1 0411	I _{AS}	11		
Single-pulse avalanche energy	L = 0 1 mH	E _{AS}	6.1	mJ	
Maximum power dissipation	T _C = 25 °C		3.1	w	
	T _C = 70 °C	_	2		
	T _A = 25 °C	P _D	2 b, c		
	T _A = 70 °C		1.3 b, c		
Operating junction and storage temperature rai	T _J , T _{sta}	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{a, d}		R _{thJA}	55	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	33	40	C/VV	

Notes

- a. Based on T_C = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 110 °C/W



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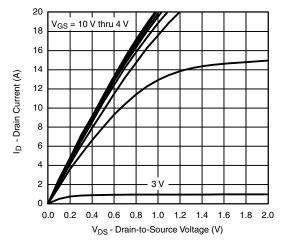
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•			•	
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	55	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6	-	mV/°C	
Oaks as an about the sale all as the sale		$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	3	.,	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 5 \text{ mA}$	-	2.5	-	V	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V	-	-	100	nA	
Zava gata valtaga dvain avvvant		V _{DS} = 60 V, V _{GS} = 0 V	-	-	1	μА	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 85 °C	-	-	10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α	
Drain-source on-state resistance a	5	$V_{GS} = 10 \text{ V}, I_D = 4.3 \text{ A}$	-	0.046	0.058		
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 3.9 \text{ A}$	-	0.059	0.072	Ω	
Forward transconductance a	9fs	V _{DS} = 15 V, I _D = 4.3 A	-	15	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	665	-		
Output capacitance	Coss	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	75	-	pF	
Reverse transfer capacitance	C _{rss}		-	40	-		
Table at a share		$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.3 \text{ A}$	-	13	20		
Total gate charge	Qg		-	6	9	nC	
Gate-source charge	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 4.3 \text{ A}$	-	2.3	-		
Gate-drain charge	Q _{gd}		-	2.6	-		
Gate resistance	Rg	f = 1 MHz	-	2	-	Ω	
Turn-on delay time	t _{d(on)}		-	15	25		
Rise time	t _r	$V_{DD} = 30 \text{ V}, R_{L} = 8.8 \Omega,$	-	65	100		
Turn-off delay time	t _{d(off)}	$I_D \cong 3.4 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	15	25		
Fall time	t _f		-	10	15		
Turn-on delay time	t _{d(on)}		-	10	15	ns	
Rise time	t _r	$V_{DD} = 30 \text{ V}, R_{L} = 8.8 \Omega,$	-	15	25	- - -	
Turn-off delay time	t _{d(off)}	$I_D \cong 3.4 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	20	30		
Fall time	t _f		-	10	15		
Drain-Source Body Diode Characteris	tics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	2.6	^	
Pulse diode forward current	I _{SM}		-	-	20	A	
Body diode voltage	V _{SD}	$I_S = 1.7 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}		-	30	60	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = 1.7 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	32	50	nC	
Reverse recovery fall time	ta	T _J = 25 °C	-	25	-		
Reverse recovery rise time	t _b		_	5	_	ns	

Notes

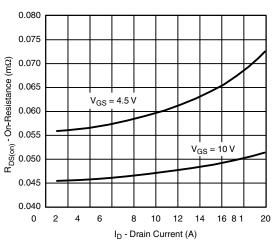
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

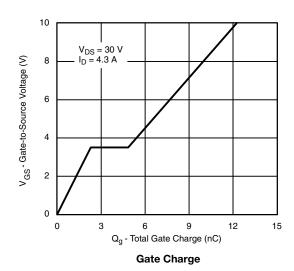


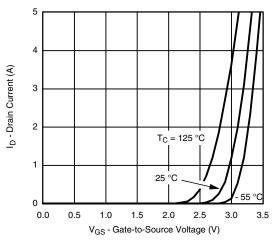


Output Characteristics

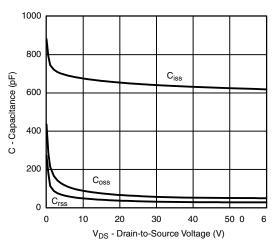


On-Resistance vs. Drain Current and Gate Voltage

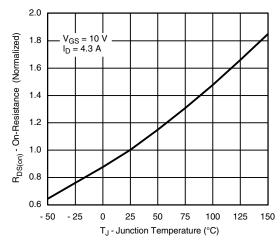




Transfer Characteristics

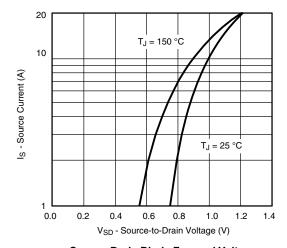


Capacitance

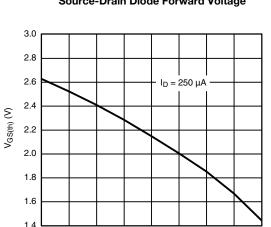


On-Resistance vs. Junction Temperature





Source-Drain Diode Forward Voltage

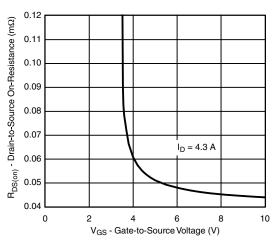


T_J - Temperature (°C) **Threshold Voltage**

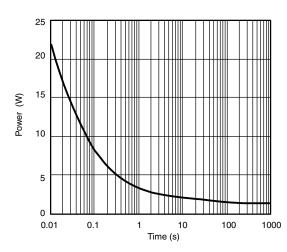
75

- 50

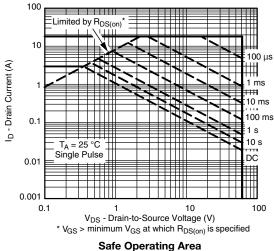
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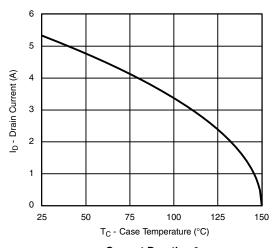
On-Resistance vs. Gate-to-Source Voltage



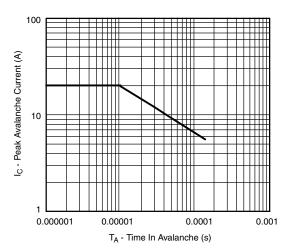
Single Pulse Power, Junction-to-Ambient



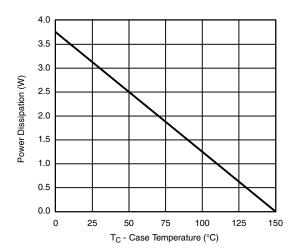




Current Derating a





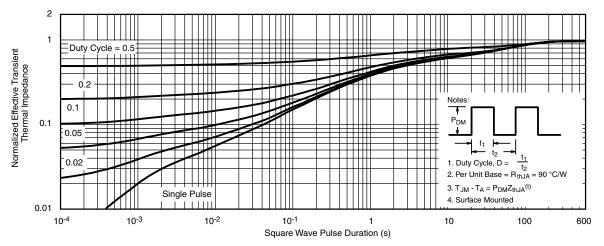


Power Derating

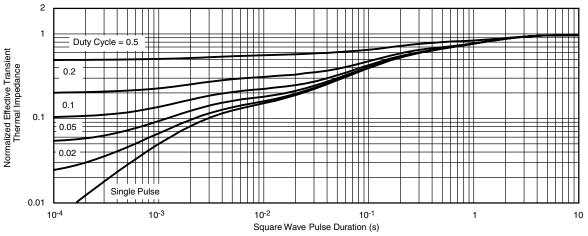
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?64737.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

LON NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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